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Texas Instruments
SN10KHT5541DW

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Datasheet of SN10KHT5541DW - IC OCT ECL-TTL XLATR 3-ST 24SOIC

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# SN10KHT5541 OCTAL ECL-TO-TTL TRANSLATOR WITH 3-STATE OUTPUTS

SDZS003A - OCTOBER 1989 - REVISED OCTOBER 1990

- 10KH Compatible
- ECL and TTL Control Inputs
- Noninverting Outputs
- Flow-Through Architecture Optimizes PCB Layout
- Center Pin V<sub>CC</sub>, V<sub>EE</sub>, and GND Configurations Minimize High-Speed Switching Noise
- Package Options Include "Small Outline" Packages and Standard Plastic 300-mil DIPs

### description

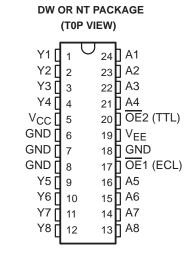
This octal ECL-to-TTL translator is designed to provide a efficient translation between a 10KH ECL signal environment and a TTL signal environment. This device is designed specifically to improve the performance and density of ECL-to-TTL CPU/bus-oriented functions such as memory-address drivers, clock drivers, and bus-oriented receivers and transmitters.

Two output-enable pins,  $\overline{OE}1$  and  $\overline{OE}2$ , are provided. These control inputs are ANDed together with  $\overline{OE}1$  being ECL compatible and  $\overline{OE}2$  being TTL compatible. This offers the choice of controlling the outputs of the device from either a TTL or ECL signal environment.

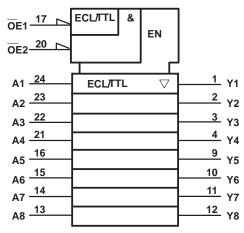
The SN10KHT5541 is characterized for operation from 0°C to 75°C.

#### **FUNCTION TABLE**

OUT	PUT	DATA	OUTPUT
ENA	BLE	INPUT	(TTL)
OE1	OE2	Α	Υ
Х	Н	Х	Z
Н	Х	Х	Z
L	L	L	L
L	L	Н	Н



# logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



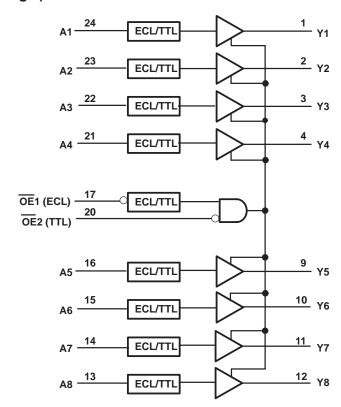


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### logic diagram (positive logic)







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# SN10KHT5541 OCTAL ECL-TO-TTL TRANSLATOR WITH 3-STATE OUTPUTS

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# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>CC</sub>	0.5 V to 7 V
Supply voltage, V <sub>EE</sub>	8 V to 0 V
Input voltage (TTL) (see Note 1)	1.2 V to 7 V
Input voltage (ECL)	V <sub>EE</sub> to 0 V
Voltage applied to any output in the disabled or power-off state	0.5 V to 5.5 V
Voltage applied to any output in the high state	0.5 V to V <sub>CC</sub>
Input current (TTL)	30 mA to 5 mA
Current into any output in the low state	96 mA
Operating free-air temperature range	0°C to 75°C
Storage temperature range	. −65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The TTL input voltage ratings may be exceeded provided the input current ratings are observed.

### recommended operating conditions

			MIN	NOM	MAX	UNIT
VCC	TTL supply voltage		4.5	5	5.5	V
VEE	ECL supply voltage		-4.94	-5.2	-5.46	V
VIH	TTL high-level input voltage		2			V
VIL	TTL low-level input voltage				0.8	V
		$T_A = 0$ °C	-1170		-840	
V <sub>IH</sub> ‡	ECL high-level input voltage	T <sub>A</sub> = 25°C	-1130		-810	mV
		T <sub>A</sub> = 75°C	-1070		-735	
		T <sub>A</sub> = 0°C	-1950		-1480	mV
∨ <sub>IL</sub> ‡	ECL low-level input voltage	T <sub>A</sub> = 25°C	-1950		-1480	
		-1950		-1450		
ΙΚ	TTL input clamp current				-18	mA
ІОН	High-level output current	·			-15	mA
loL	Low-level output current				48	mA
TA	Operating free-air temperature		0		75	°C

<sup>‡</sup> The algebraic convention, in which the least positive (most negative) value is designated minimum, is used in this data sheet for logic levels only.





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# SN10KHT5541 OCTAL ECL-TO-TTL TRANSLATOR WITH 3-STATE OUTPUTS SDZS003A - OCTOBER 1989 - REVISED OCTOBER 1990

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST COND	MIN	TYP <sup>†</sup>	MAX	UNIT			
VIK	OE2 only	$V_{CC} = 4.5 \text{ V},$	V <sub>EE</sub> = -4.94 V,	I <sub>I</sub> = -18 mA				-1.2	V	
ΙĮ	OE2 only	V <sub>CC</sub> = 5.5 V,	$V_{EE} = -5.46 \text{ V},$	V <sub>I</sub> = 7 V				0.1	mA	
lН	OE2 only	$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -5.46 \text{ V},$	V <sub>I</sub> = 2.7 V				20	μΑ	
Ι <sub>Ι</sub> L	OE2 only	$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -5.46 \text{ V},$	V <sub>I</sub> = 0.5 V				-0.5	mA	
		$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -5.46 \text{ V},$	$V_{I} = -840 \text{ mV}$	$T_A = 0$ °C			350		
lн	Data inputs and OE1	$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -5.46 \text{ V},$	$V_{I} = -810 \text{ mV}$	T <sub>A</sub> = 25°C			350	μΑ	
		$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -5.46 \text{ V},$	$V_{I} = -735 \text{ mV}$	T <sub>A</sub> = 75°C			350		
	Data inputs and OE1		V <sub>EE</sub> = -5.46 V,	V <sub>I</sub> = –1950 mV	T <sub>A</sub> = 0°C	0.5				
Ι <sub>Ι</sub> L		V <sub>CC</sub> = 5.5 V,			T <sub>A</sub> = 25°C	0.5			μΑ	
					T <sub>A</sub> = 75°C	0.5				
V		$V_{CC} = 4.5 \text{ V},$	$V_{EE} = -5.2 \text{ V} \pm 5\%$ ,	$I_{OH} = -3 \text{ mA}$		2.4	3.3		V	
VOH		$V_{CC} = 4.5 \text{ V},$	$V_{EE} = -5.2 \text{ V} \pm 5\%$ ,	I <sub>OH</sub> = -15 mA		2	3.1		·	
VOL		$V_{CC} = 4.5 \text{ V},$	$V_{EE} = -5.2 \text{ V} \pm 5\%$ ,	$I_{OL} = 48 \text{ mA}$			0.38	0.55	V	
lozh		$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -5.46 \text{ V},$	$V_0 = 2.7 \text{ V}$				50	μΑ	
lozL		$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -5.46 \text{ V},$	$V_0 = 0.5 V$				-50	μΑ	
los‡		$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -5.46 \text{ V},$	VO = 0		-100		-225	mA	
ICCH		$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -5.46 \text{ V}$				64	97	mA	
ICCL		V <sub>CC</sub> = 5.5 V,	V <sub>EE</sub> = −5.46 V				80	120	mA	
ICCZ		$V_{CC} = 5.5 \text{ V},$	V <sub>EE</sub> = −5.46 V		·		77	116	mA	
IEE		$V_{CC} = 5.5 V$ ,	V <sub>EE</sub> = −5.46 V	·			-22	-33	mA	
Ci		V <sub>CC</sub> = 5 V,	V <sub>EE</sub> = −5.2 V	<u> </u>			5		pF	
Co		V <sub>CC</sub> = 5 V,	V <sub>EE</sub> = −5.2 V				7		pF	

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $V_{EE} = -5.2 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

# switching characteristics over recommended ranges of operating free-air temperature and supply voltage (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C R R	UNIT		
			MIN	TYP§	MAX	
<sup>t</sup> PLH	А	<b>V</b>	1.7	4	6.2	ns
<sup>t</sup> PHL	Α.	'	1.6	4	6.2	
<sup>t</sup> PZH	OE1	Υ	2.6	4.7	6.7	ns
<sup>t</sup> PZL	OE I	Y	3.2	5.9	8.5	
<sup>t</sup> PHZ	ŌE1	Υ	2.9	5.4	7.8	ns
<sup>t</sup> PLZ	OE1		1.9	4.9	7.8	
<sup>t</sup> PZH	OE2	Y	1.7	4	6.2	ns
<sup>t</sup> PZL	OE2	1	2.5	5.1	7.7	115
<sup>t</sup> PHZ	OE2	٧	2.1	4.3	6.4	
tpLZ	UE2	Y	1.1	3.7	6.3	ns

<sup>§</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $V_{EE} = -5.2 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .



<sup>‡</sup> Not more than one output should be tested at a time and the duration of the test should not exceed 10 ms.

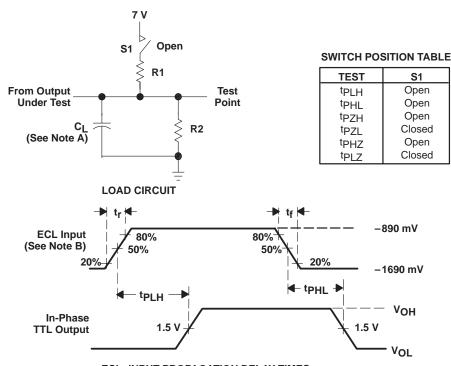
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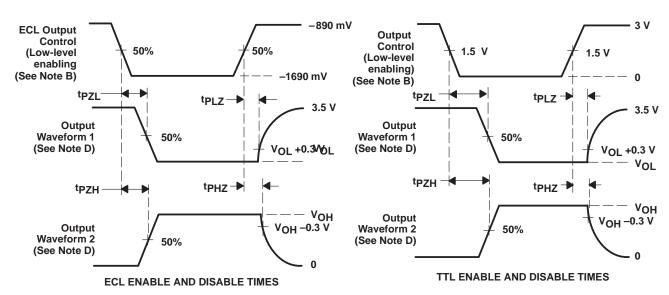
# SN10KHT5541 OCTAL ECL-TO-TTL TRANSLATOR WITH 3-STATE OUTPUTS

SDZS003A - OCTOBER 1989 - REVISED OCTOBER 1990

### PARAMETER MEASUREMENT INFORMATION



**ECL-INPUT PROPAGATION DELAY TIMES** 



- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. For TTL inputs, input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_0 = 50 \Omega$ ,  $t_f \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - C. For ECL inputs, input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_0 = 50 \Omega$ ,  $t_f \leq$  0.7 ns,  $t_f \leq$  0.7 ns.
  - D. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - E. The outputs are measured one at a time with one transition per measurement.

### FIGURE 1. LOAD CIRCUIT AND VOLTAGE WAVEFORMS





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PACKAGE OPTION ADDENDUM

15-Oct-2015

#### PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
SN10KHT5541DW	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	10KHT5541	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Ti's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device
- (6) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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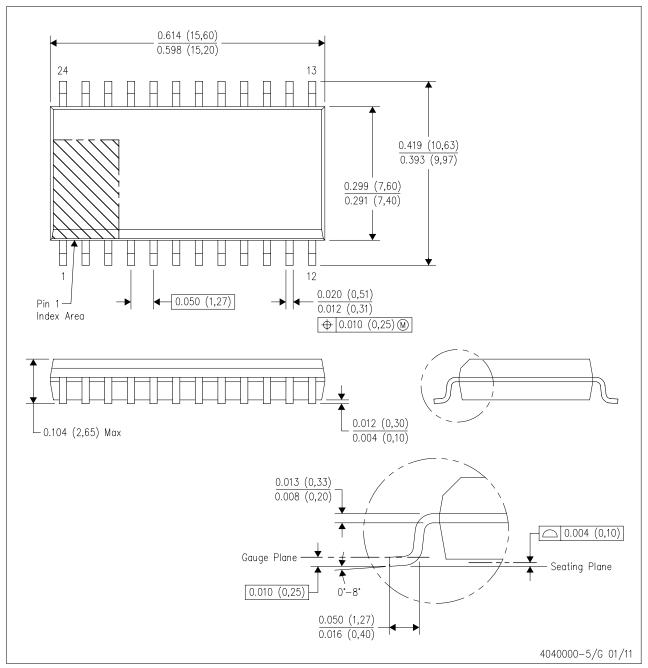
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## **MECHANICAL DATA**

DW (R-PDSO-G24)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M—1994.

- 3. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AD.





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